

# **HOMs ceramics absorbers**

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Date







#### **HOM material issue**

Ekasic P is no longer available in the market as it was, change of the additives and it can influence or not in the performance.

There is no data why this material is working well but it is, so for finding a substitute we have ask Ping to run some measurements and we have asked 2 different materials from different suppliers

Mention, the <u>cost surge</u> because of the complicated shape. Can we carry out a sim of the tolerances we can accept?

I will work and a better holding method to make it simpler.

Materials		Ekasic P	Ekasic F	SC-C	Boostec
Density	g/cm3	2.76-2.89	3.15	3.12	3.2
Porosity	%	10 - 14	<2	<3	1.5
Hardness	GPa	24.5	24.5	22	22
Thermal expansion (Coef)	10e-6/K	3.8	3.8	3.3	2.2
Thermal conductivity	w/mK	110	130	120	180
Specific electrical resistance	Ohm*cm	>10e8	>10e3	10e5-10e7	10e6-10e9







## **HOM References**

https://edms.cern.ch/document/997123/1

https://edms.cern.ch/document/1009247/1

https://edms.cern.ch/document/1059157/1

https://edms.cern.ch/document/1211574/1

https://www.researchgate.net/publication/254469450 Analysis of longrange wakefields in CLIC main Linac Accelerating Structures with Damping Loads

CERN-OPEN-2008-019.pdf

https://indico.cern.ch/event/142416/contributions/1375573/attachments/129021/183157/gdemich e20110623-up.pdf

https://indico.cern.ch/event/72077/contributions/2074694/attachments/1036307/1476627/RF\_development\_meeting\_13\_01\_10.pdf



## **Parameters of material definition**

MAIN CHARACTERISTICS THAT MUST BE CONSIDERED FOR THE SELECTION OF  $20 < \epsilon r < 40 // 0.2 < tan \delta < 0.4$ **RF ABSORBER** ✤ THE ELECTRIC OR MAGNETIC LOSS HAVE TO BE HIGH AT THE HOM FREQUENCIES.  $\epsilon r$  = relative permittivity or real part of the permittivity  $tan\delta$  = loss tangent or tangent delta or Dielectric loss ♦ LOW DIELECTRIC CONSTANT AND PERMEABILITY AT THE HOM FREQUENCIES TO ALLOW AN ADEQUATE PENETRATION OF THE RF FIELDS INTO THE SELECTED ABSORBING MATERIAL. Reference ♦ GOOD THERMAL CONDUCTIVITY TO PREVENT AN EXCESSIVE HEATING OF THE MATERIAL DURING THE RF POWER DISSIPATION  $15 < \epsilon < 25 // \tan \delta > 0.3$ ✤ AT CRYOGENIC TEMPERATURES, IS NECESSARY TO EVALUATE THE THERMAL CONTRACTION Reference ♦ A LOW OUT GASSING RATE, SO THE MATERIAL COULD BE INSIDE HIGH VACUUM SYSTEMS.  $\epsilon$  < 20 (as low as possible) // tan $\delta$  > 0.3 General Standard procedure to measure it: Reference "Material for the loads must have  $\varepsilon$ ' in the range of ASTM-D150 11-14 and  $tan \delta > 0.15$ " Dielectric Constant and Dissipation Factor ASTM D150, IEC 60250 (intertek.com) Reference



### **Manufacturers and material suppliers**

- They don't measure (normally) those parameters and even less in the frequency ranges we need to explore.
- Can we rely on their results given the fact that some of them are not following any procedure to measure the parameters?
- Supply ussies. Not really much availability on the market. If we foreseen this with time there is no issue there.
- Redesign of the current proposal to get something easier to machine. Keep the symmetrical advantages and the poka-yoke
- Any comments on the mechanical properties? Porosity? Ekasic P was the more porous one. Density is important? CTE bellow 5 should works.



### **Materials summary**

**Excel table** 





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